

Low Vcesat NPN Epitaxial Planar Transistor

BTD1805I3

Description

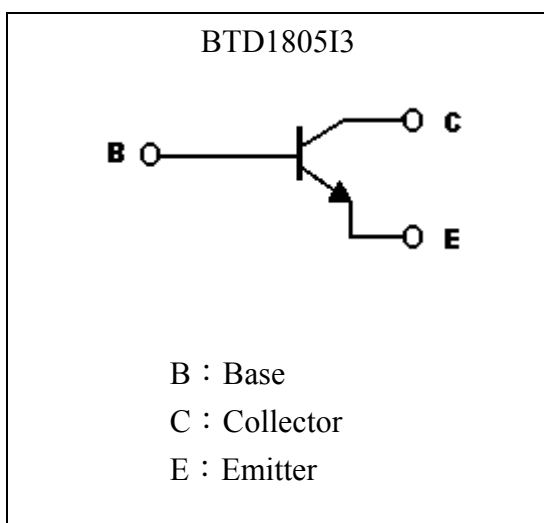
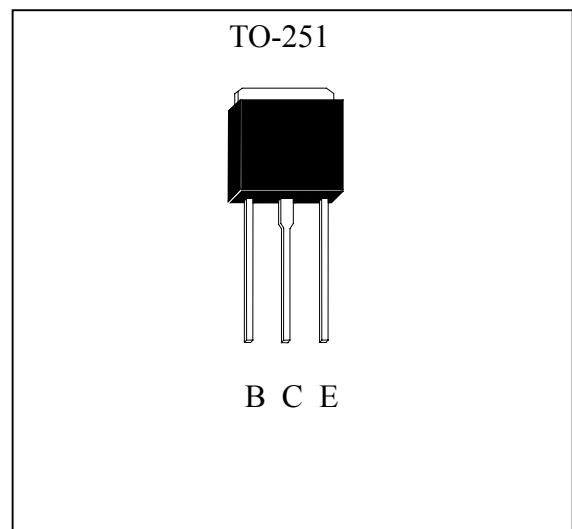
The device is manufactured in NPN planar technology by using a “Base Island” layout. The resulting transistor shows exceptional high gain performance coupled with very low saturation voltage.

Features

- Very low collector-to-emitter saturation voltage
- Fast switching speed
- High current gain characteristic
- Large current capability

Applications

- CCFL drivers
- Voltage regulators
- Relay drivers
- High efficiency low voltage switching applications

Symbol**Outline**



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-Base Voltage (IE=0)	V _{CBO}	150	V
Collector-Emitter Voltage (IB=0)	V _{CEO}	60	V
Emitter-Base Voltage (IC=0)	V _{EBO}	7	V
Collector Current (DC)	I _C	5	A
Collector Current (Pulse)	I _{CP}	10 (Note 1)	
Base Current	I _B	2	A
Power Dissipation @ Ta=25°C	P _D	1	W
Power Dissipation @ Tc=25°C	P _D	15	
Thermal Resistance, Junction to Ambient	R _{θJA}	125	°C/W
Thermal Resistance, Junction to Case	R _{θJC}	8.33	°C/W
Junction Temperature	T _j	150	°C
Storage Temperature	T _{stg}	-55~+150	°C

Note : 1. Single Pulse , Pw ≤ 380μs, Duty ≤ 2%.

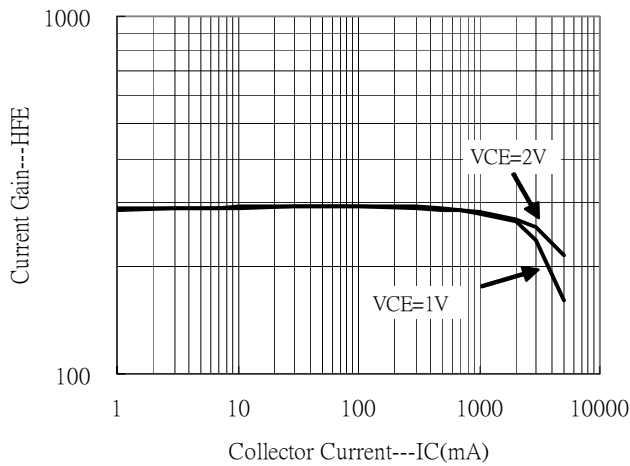
Characteristics (Ta=25°C)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
BV _{CBO}	150	-	-	V	I _C =100μA, I _E =0
*BV _{CEO}	60	-	-	V	I _C =1mA, I _B =0
BV _{EBO}	7	-	-	V	I _C =100μA, I _C =0
I _{CBO}	-	-	0.1	μA	V _{CB} =80V, I _E =0
I _{EBO}	-	-	0.1	μA	V _{EB} =4V, I _C =0
*V _{CE(sat)} 1	-	-	50	mV	I _C =100mA, I _B =5mA
*V _{CE(sat)} 2	-	200	300	mV	I _C =2A, I _B =50mA
*V _{CE(sat)} 3	-	240	400	mV	I _C =3A, I _B =150mA
*V _{CE(sat)} 4	-	-	600	mV	I _C =5A, I _B =200mA
*V _{BE(sat)}	-	0.9	1.2	V	I _C =2A, I _B =100mA
*h _{FE} 1	200	-	400	-	V _{CE} =2V, I _C =100mA
*h _{FE} 2	85	-	-	-	V _{CE} =2V, I _C =5A
*h _{FE} 3	20	-	-	-	V _{CE} =2V, I _C =10A
f _T	-	150	-	MHz	V _{CE} =10V, I _C =50mA
Cob	-	50	-	pF	V _{CB} =10V, f=1MHz
t _{on}	-	50	-	ns	V _{CC} =30V, I _C =10I _{B1} =-10I _{B2} =1A, R _L =30Ω
t _{stg}	-	1.35	-	μs	
t _f	-	120	-	ns	

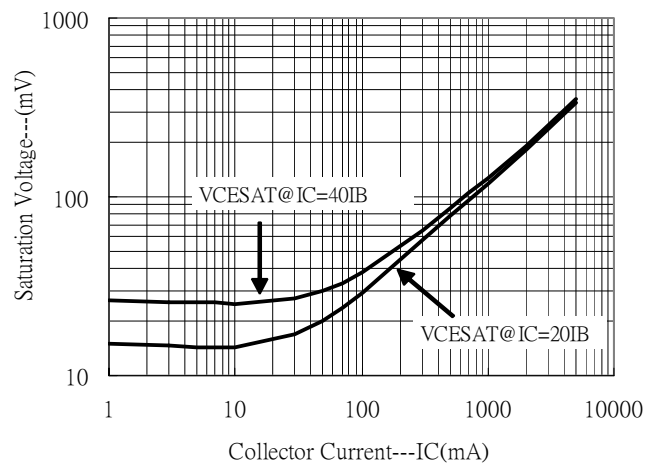
*Pulse Test : Pulse Width ≤ 380μs, Duty Cycle ≤ 2%

Characteristic Curves

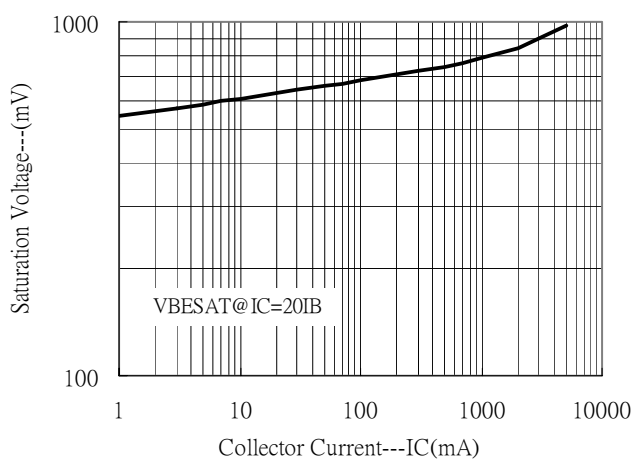
Current Gain vs Collector Current



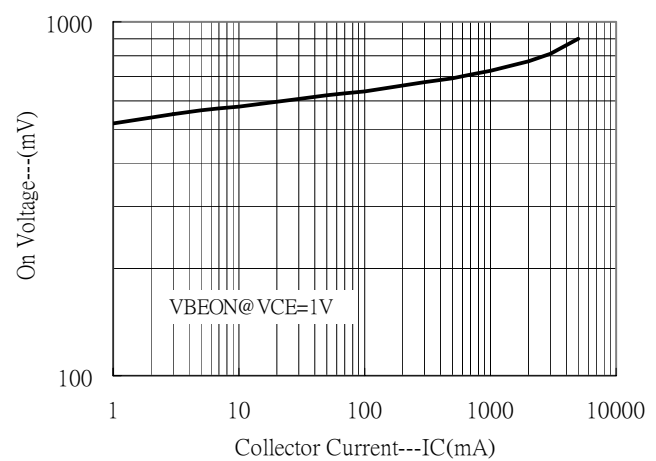
Saturation Voltage vs Collector Current



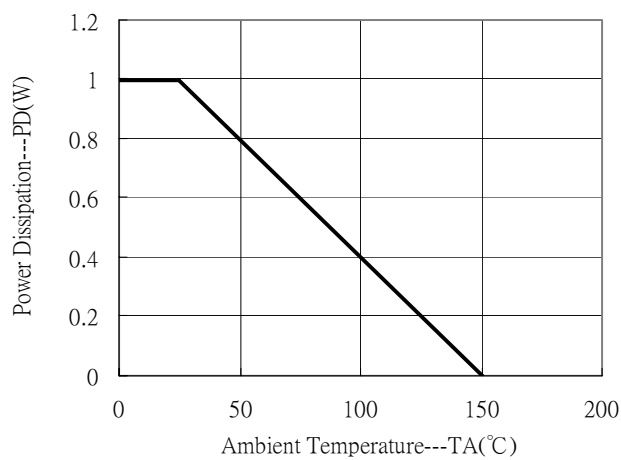
Saturation Voltage vs Collector Current



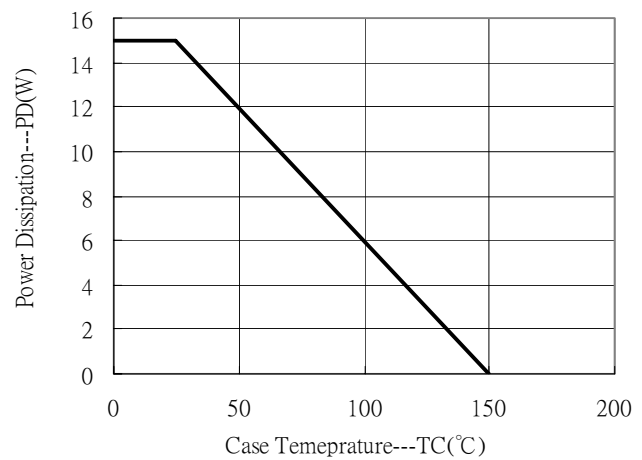
On Voltage vs Collector Current



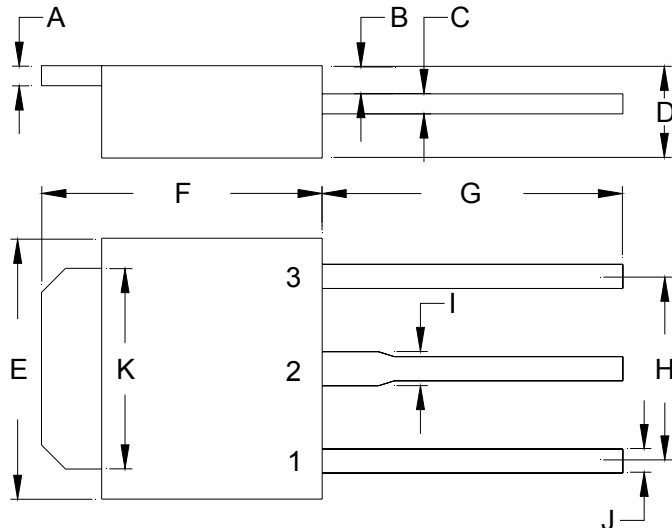
Power Derating Curve



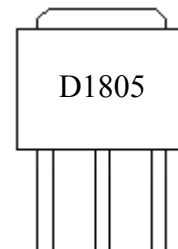
Power Derating Curve



TO-251 Dimension



Marking:



Style: Pin 1.Base 2.Collector 3.Emitter

3-Lead TO-251 Plastic Package
 CYStek Package Code: I3

*: Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.0177	0.0217	0.45	0.55	G	0.2559	-	6.50	-
B	0.0354	0.0591	0.90	1.50	H	-	*0.1811	-	*4.60
C	0.0177	0.0236	0.45	0.60	I	-	0.0354	-	0.90
D	0.0866	0.0945	2.20	2.40	J	-	0.0315	-	0.80
E	0.2520	0.2677	6.40	6.80	K	0.2047	0.2165	5.20	5.50
F	0.2677	0.2835	6.80	7.20					

Notes: 1.Controlling dimension: millimeters.

2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.

3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead: 42 Alloy; solder plating
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0

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